

65,536 x 1 BIT DYNAMIC
RANDOM ACCESS MEMORY

PRELIMINARY

DESCRIPTION The NEC μPD4164 is a 65,536 words by 1 bit Dynamic N-Channel MOS RAM designed to operate from a single +5V power supply. The negative-voltage substrate bias is internally generated — its operation is both automatic and transparent.

The μPD4164 utilizes a double-poly-layer N-channel silicon gate process which provides high storage cell density, high performance and high reliability.

The μPD4164 uses a single transistor dynamic storage cell and advanced dynamic circuitry throughout, including the 512 sense amplifiers, which assures that power dissipation is minimized. Refresh characteristics have been chosen to maximize yield (low cost to user) while maintaining compatibility between Dynamic RAM generations.

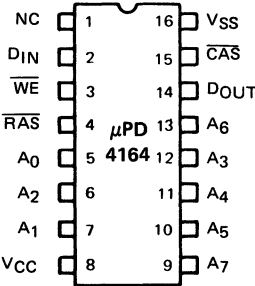
The μPD4164 three-state output is controlled by $\overline{\text{CAS}}$, independent of $\overline{\text{RAS}}$. After a valid read or read-modify-write cycle, data is held on the output by holding $\overline{\text{CAS}}$ low. The data out pin is returned to the high impedance state by returning $\overline{\text{CAS}}$ to a high state. The μPD4164 hidden refresh feature allows $\overline{\text{CAS}}$ to be held low to maintain output data while $\overline{\text{RAS}}$ is used to execute $\overline{\text{RAS}}$ only refresh cycles.

Refreshing is accomplished by performing $\overline{\text{RAS}}$ only refresh cycles, hidden refresh cycles, or normal read or write cycles on the 128 address combinations of A₀ through A₆ during a 2 ms period.

Multiplexed address inputs permit the μPD4164 to be packaged in the standard 16 pin dual-in-line package. The 16 pin package provides the highest system bit densities and is compatible with widely available automated handling equipment.

- FEATURES**
- High Memory Density
 - Multiplexed Address Inputs
 - Single +5V Supply
 - On Chip Substrate Bias Generator
 - Access Time: μPD4164-1 — 250 ns
μPD4164-2 — 200 ns
μPD4164-3 — 150 ns
 - Read, Write Cycle Time: μPD4164-1 — 410 ns
μPD4164-2 — 335 ns
μPD4164-3 — 270 ns
 - Low Power Dissipation: 250 mW (Active); 28 mW (Standby)
 - Non-Latched Output is Three-State, TTL Compatible
 - Read, Write, Read-Write; Read-Modify-Write, $\overline{\text{RAS}}$ Only Refresh, and Page Mode Capability
 - All Inputs TTL Compatible, and Low Input Capacitance
 - 128 Refresh Cycles (A₀-A₆ Pins for Refresh Address)
 - $\overline{\text{CAS}}$ Controlled Output Allows Hidden Refresh
 - Available in Both Ceramic and Plastic 16 Pin Packages

PIN CONFIGURATION



PIN NAMES

A ₀ -A ₇	Address Inputs
$\overline{\text{RAS}}$	Row Address Strobe
$\overline{\text{CAS}}$	Column Address Strobe
$\overline{\text{WE}}$	Write Enable
D _{IN}	Data Input
D _{OUT}	Data Output
V _{CC}	Power Supply (+5V)
V _{SS}	Ground
NC	No Connection

μPD4164

Operating Temperature 0°C to +70°C
Storage Temperature (Ceramic Package) -55°C to +150°C
(Plastic Package) -55°C to +125°C
Supply Voltages On Any Pin Except V_{CC} -1 to +7 Volts ①
Supply Voltage V_{CC} -0.5 to +7 Volts ①
Short Circuit Output Current 50 mA
Power Dissipation 1 Watt

ABSOLUTE MAXIMUM RATINGS*

Note: ① Relative to V_{SS}

COMMENT: Stress above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

*T_a = 25°C

T_a = 0° to 70°C ① : V_{CC} = +5V ± 10%; V_{SS} = 0V

DC CHARACTERISTICS

PARAMETER	SYMBOL	LIMITS			UNIT	TEST CONDITIONS
		MIN	TYP	MAX		
Supply Voltage	V _{CC}	4.5	5.0	5.5	V	All Voltages Referenced to V _{SS}
	V _{SS}	0	0	0	V	
High Level Input Voltage, (RAS, CAS, WE)	V _{IHC}	2.4		5.5	V	
High Level Input Voltage, All Inputs Except RAS, CAS, WE	V _{IH}	2.4		5.5	V	
Low Level Input Voltage, All Inputs	V _{IL}	-2.0		0.8	V	
Operating Current	I _{CC1}	μPD4164-1		45	mA	②
Average Power Supply		μPD4164-2		50		
Operating Current		μPD4164-3		60		
RAS, CAS Cycling; t _{RC} = t _{RC} (Min.)						
Standby Current	I _{CC2}			5.0	mA	
Power Supply Standby Current (RAS = V _{IHC} , D _{OUT} = Hi-Impedance)						
Refresh Current	I _{CC3}	μPD4164-1		35	mA	②
Average Power Supply		μPD4164-2		40		
Current, Refresh Mode;		μPD4164-3		45		
RAS Cycling, CAS = V _{IHC} , t _{RC} = t _{RC} (Min.)						
Page Mode Current	I _{CC4}	μPD4164-1		35	mA	②
Average Power Supply		μPD4164-2		40		
Current, Page Mode Operation		μPD4164-3		45		
RAS = V _{IL} ; CAS Cycling t _{PC} = t _{PC} (Min.)						
Input Leakage Current Any Input	I _{I(L)}	-10		10	μA	
V _{IN} = 0 to +5.5 Volts, All Other Pins Not Under Test = 0V						
Output Leakage Current D _{OUT} is Disabled, V _{OUT} = 0 to +5.5 Volts	I _{O(L)}	-10		10	μA	
Output Levels	V _{OH}	2.4		V _{CC}	V	
High Level Output Voltage (I _{OUT} = 5 mA)						
Low Level Output Voltage (I _{OUT} = 4.2 mA)	V _{OL}	0		0.4	V	

Notes: ① T_a is specified here for operation at frequencies to t_{RC} ≥ t_{RC} (min). Operation at higher cycle rates with reduced ambient temperatures and high power dissipation is permissible, however, provided AC operating parameters are met.
② I_{CC1}, I_{CC3} and I_{CC4} depend on output loading and cycle rates. Specified rates are obtained with the output open.

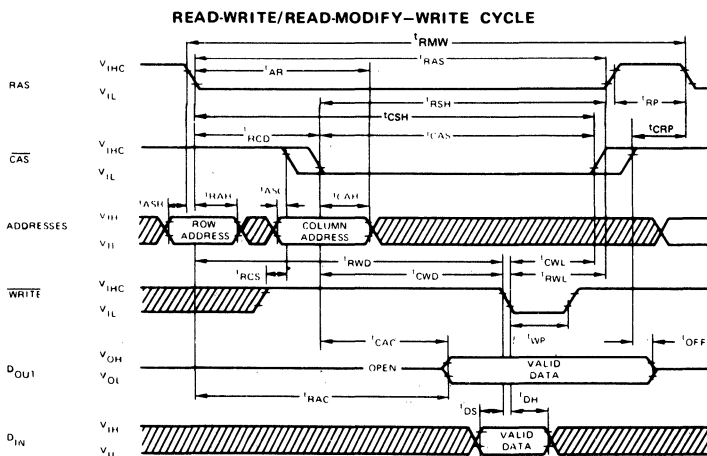
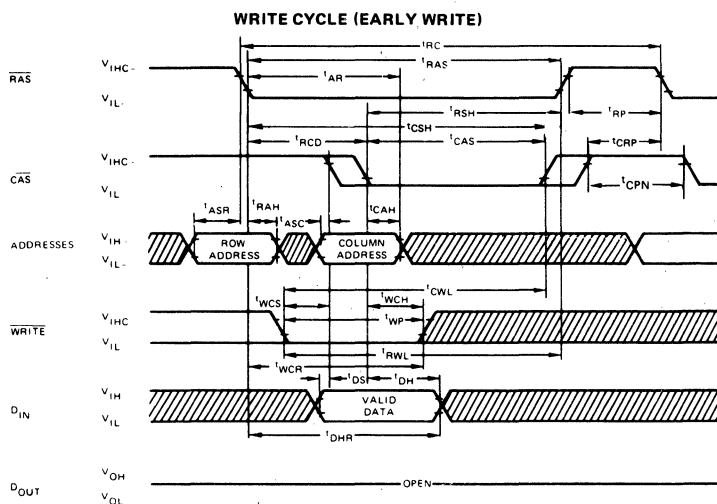
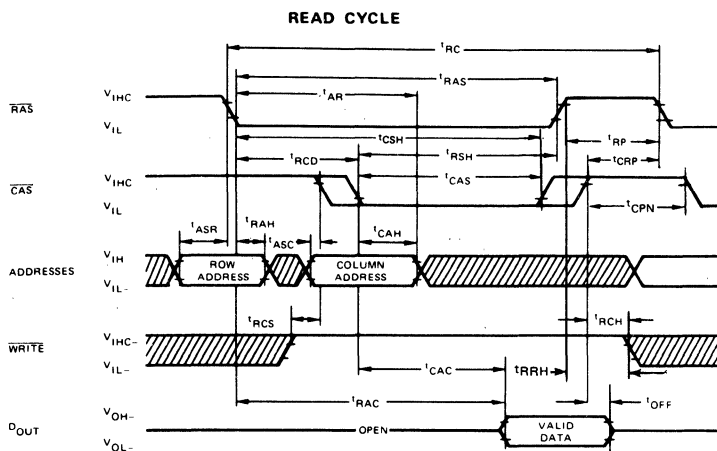
AC CHARACTERISTICS

T_a = 0° to +70° C ①, V_{CC} = +5V ± 10%; V_{SS} = 0V ③ ④

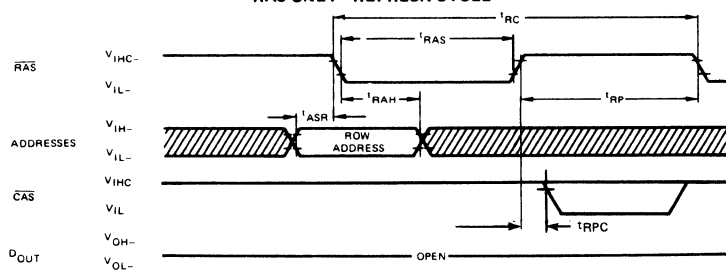
PARAMETER	SYMBOL	LIMITS						UNIT	TEST CONDITIONS
		μPD4164-1		μPD4164-2		μPD4164-3			
		MIN	MAX	MIN	MAX	MIN	MAX		
Random Read or Write Cycle Time	t _{RC}	410		335		270		ns	⑤
Read Write Cycle Time	t _{RWC}	465		335		270		ns	⑤
Page Mode Cycle Time	t _{PC}	275		225		170		ns	
Access Time from RAS	t _{RAC}		250		200		150	ns	⑥ ⑧
Access Time from CAS	t _{CAC}		165		135		100	ns	⑦ ⑧
Output Buffer Turn-Off Delay	t _{OFF}	0	60	0	50	0	40	ns	⑨
Transition Time (Rise and Fall)	t _T	3	50	3	50	3	50	ns	④
RAS Precharge Time	t _{RP}	150		120		100		ns	
RAS Pulse Width	t _{RAS}	250	10,000	200	10,000	150	10,000	ns	
RAS Hold Time	t _{RAH}	165		135		100		ns	
CAS Pulse Width	t _{CAS}	165	10,000	135	10,000	100	10,000	ns	
CAS Hold Time	t _{CAH}	250		200		150		ns	
RAS to CAS Delay Time	t _{RCD}	35	85	30	65	25	50	ns	⑩
CAS to RAS Precharge Time	t _{CRP}	0		0		0		ns	
CAS Precharge Time	t _{CPN}	35		30		25		ns	
CAS Precharge Time (For Page Mode Cycle Only)	t _{CP}	100		80		60		ns	
RAS Precharge CAS Hold Time	t _{RPC}	0		0		0		ns	
Row Address Set-Up Time	t _{ASR}	0		0		0		ns	
Row Address Hold Time	t _{RAH}	25		20		15		ns	
Column Address Set-Up Time	t _{ASC}	0		0		0		ns	
Column Address Hold Time	t _{CAH}	75		55		45		ns	
Column Address Hold Time Referenced to RAS	t _{AR}	160		120		95		ns	
Read Command Set-Up Time	t _{RCS}	0		0		0		ns	
Read Command Hold Time Referenced to RAS	t _{RRH}	30		25		20		ns	⑬
Read Command Hold Time	t _{RCH}	0		0		0		ns	⑬
Write Command Hold Time	t _{WCH}	75		55		45		ns	
Write Command Hold Time Referenced to RAS	t _{WCR}	160		120		95		ns	
Write Command Pulse Width	t _{WP}	75		55		45		ns	
Write Command to RAS Lead Time	t _{RWL}	100		55		45		ns	
Write Command to CAS Lead Time	t _{CWL}	100		55		45		ns	
Data-In Set-Up Time	t _{DS}	0		0		0		ns	⑪
Data-In Hold Time	t _{DH}	75		55		45		ns	⑪
Data-In Hold Time Referenced to RAS	t _{DHR}	160		120		95		ns	
Refresh Period	t _{REF}		2		2		2	ms	
WRITE Command Set-Up Time	t _{WCS}	-20		-20		-20		ns	⑫
CAS to WRITE Delay	t _{CWD}	115		80		60		ns	⑫
RAS to WRITE Delay	t _{RWD}	200		145		110		ns	⑫

- Notes: ① T_a is specified here for operation at frequencies to t_{RC} ≥ t_{RC} (min). Operation at higher cycle rates with reduced ambient temperature and higher power dissipation is permissible, however, provided AC operating parameters are met.
- ② An initial pause of 100 μs is required after power-up followed by any 8 RAS cycles before proper device operation is achieved.
- ③ AC measurements assume t_T = 5 ns.
- ④ V_{IHC} (min) or V_{IH} (min) and V_{IL} (max) are reference levels for measuring timing of input signals. Also, transition times are measured between V_{IHC} or V_{IH} and V_{IL}.
- ⑤ The specifications for t_{RC} (min) and t_{RWC} (min) are used only to indicate cycle times at which proper operation over the full temperature range (0° C ≤ T_a ≤ 70° C) is assured.
- ⑥ Assumes that t_{RCS} ≤ t_{RCD} (max). If t_{RCS} is greater than the maximum recommended value shown in this table, t_{RAC} will increase by the amount that t_{RCD} exceeds the values shown.
- ⑦ Assumes that t_{RCD} ≥ t_{RCD} (max).
- ⑧ Measured with a load equivalent to 2 TTL loads and 100 pF.
- ⑨ t_{OFF} (max) defines the time at which the output achieves the open circuit condition and is not referenced to output voltage levels.
- ⑩ Operation within the t_{RCD} (max) limit ensures that t_{RAC} (max) can be met. t_{RCD} (max) is specified as a reference point only. If t_{RCD} is greater than the specified t_{RCD} (max) limit, then access time is controlled exclusively by t_{CAC}.
- ⑪ These parameters are referenced to CAS leading edge in early write cycles and to WRITE leading edge in delayed write or read-modify-write cycles.
- ⑫ t_{WCS}, t_{CWD} and t_{RWD} are restrictive operating parameters in read-write and read-modify-write cycles only. If t_{WCS} ≥ t_{WCS} (min), the cycle is an early write cycle and the data output will remain open circuit throughout the entire cycle. If t_{CWD} > t_{CWD} (min) and t_{RWD} > t_{RWD} (min), the cycle is a read-write and the data output will contain data read from the selected cell. If neither of the above conditions are met the condition of the data out (at access time and until CAS goes back to V_{IH}) is indeterminate.
- ⑬ Either t_{RRH} or t_{RCH} must be satisfied for a read cycle.

TIMING WAVEFORMS



"RAS-ONLY" REFRESH CYCLE

[illegible]

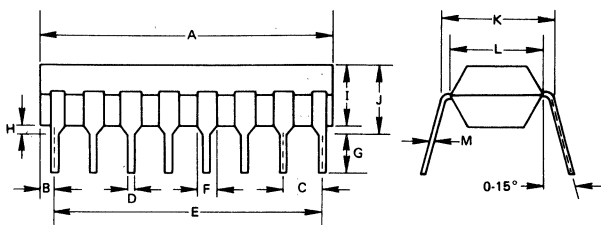
The timing diagram illustrates the sequence of signals for the 64K1602 LCD controller. The signals shown are RAS, CAS, ADDRESSES, DOUT, and WRITE. The diagram includes various timing parameters such as t_{RAS} , t_{AR} , t_{CSH} , t_{PC} , t_{CAS} , t_{RSH} , t_{RP} , t_{RCD} , t_{CAS} , t_{CP} , t_{CAS} , t_{CRP} , t_{AH} , t_{CAH} , t_{ASC} , t_{CAH} , t_{CAC} , t_{RAC} , t_{OFF} , t_{GFF} , t_{QFF} , t_{RCS} , t_{RCH} , and t_{RCH} .

μPD4164

T_a = 0° to +70°C; V_{CC} = +5V ± 10%; V_{SS} = 0V

CAPACITANCE

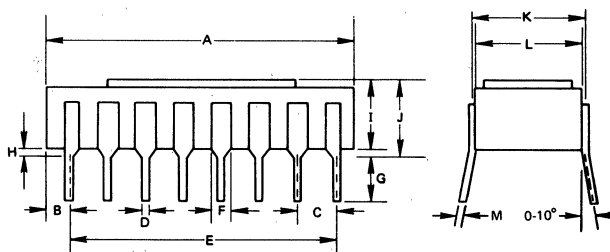
PARAMETER	SYMBOL	LIMITS			UNIT	TEST CONDITIONS
		MIN	TYP	MAX		
Input Capacitance (A ₀ -A ₇), D _{IN}	C _{I1}		5	6	pF	
Input Capacitance RAS, CAS, WRITE	C _{I2}			10	pF	
Output Capacitance (D _{OUT})	C _O			7	pF	



PACKAGE OUTLINES μPD4164C

Plastic

ITEM	MILLIMETERS	INCHES
A	19.4 MAX.	0.76 MAX.
B	0.81	0.03
C	2.54	0.10
D	0.5	0.02
E	17.78	0.70
F	1.3	0.051
G	2.54 MIN.	0.10 MIN.
H	0.5 MIN.	0.02 MIN.
I	4.05 MAX.	0.16 MAX.
J	4.55 MAX.	0.18 MAX.
K	7.62	0.30
L	6.4	0.25
M	0.25 ^{+0.10} _{-0.05}	0.01



μPD4164D

Ceramic

ITEM	MILLIMETERS	INCHES
A	20.5 MAX.	0.81 MAX.
B	1.36	0.05
C	2.54	0.10
D	0.5	0.02
E	17.78	0.70
F	1.3	0.051
G	3.5 MIN.	0.14 MIN.
H	0.5 MIN.	0.02 MIN.
I	4.6 MAX.	0.18 MAX.
J	5.1 MAX.	0.20 MAX.
K	7.6	0.30
L	7.3	0.29
M	0.27	0.01